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#### 1.0 Features

Small Board Size

- Entire circuit can fit on less than 1 square inch of PCB space
- Low Implementation Cost
  - Fewer than 4 discrete components required
- ON /OFF Control
  - Be controlled by external logic level signal
- Thermal Shut-Down and Current Limit
  - Built-in function
- Simple Feedback Compensation
  - Lead compensation using external capacitor
- Immediate Implementation
  - Schematic, board-of-materials and board layout available from Anachip

#### 2.0 Introduction

This application note discusses simple ways to select all necessary components to implement a step-down (BUCK) regulator and gives a design example. In this example, the AP1507 monolithic IC is used to design a cost-effective and high-efficiency miniature switching buck regulator. For more complete information, pin descriptions and specifications for the AP1507, please refer to the datasheet when designing or evaluating the AP1507.

This demonstration board allows the designer to evaluate the performance of the AP1507 series buck regulator in a typical application circuit. The user needs only to supply an input voltage and a load. The demonstration board can be configured to evaluate a fixed output voltage of 3.3V, 5V, 12V, and an adjustable output version of the AP1507 series. Operation at other voltages and currents may be accomplished by proper component selection and replacement.



#### 3.0 Regulator Design Procedure

#### 3.0.1 Given Power Specification

 $V_{\scriptscriptstyle IN({
m max})}$  = Maximum Input Voltage

 $V_{\scriptscriptstyle I\! N ext{(min)}}$  = Minimum Input Voltage

 $V_{\scriptscriptstyle OUT}$  = Regulated Output Voltage

 $V_{\scriptscriptstyle RIPPLF}$  = Ripple Voltage (peak-to-peak), typical value is 1% of the Output Voltage

 $I_{LOAD(\max)}$  = Maximum Load Current

 $I_{LOAD ({
m min})}$  = Minimum Load Current before the circuit becomes discontinuous, typical value is 10% of the maximum load current

F = Switching Frequency (fixed at a nominal 150kHz)

### 3.0.2 Programming Output Voltage (refer to 4.0.4 Demo Board Schematic P7)

The output voltage is programmed by selection of the divider R1 and R2. Designer should use resistors R1 and R2 with ±1% tolerance in order to obtain best accuracy of Output Voltage. The Output Voltage can be calculated from the following formula:

$$V_{out} = 1.23 x (1 + R1/R2)$$

Select a value for R2 between  $240\Omega$  and  $1.5K\Omega$ . The lower resistor values minimize noise pickup in the sensitive feedback pin.

If the designer selects a fixed output version of the AP1507, the resistor R1 shall be short and R2 shall be open.

#### 3.0.3 Inductor Selection

**A.** The minimum inductor  $L_{ ext{(min)}}$  can be calculated from the following design formula table:

Calculation	Step-down (buck) regulator		
$T_{\mathit{ON}}$	$(V_{\scriptscriptstyle OUT} + V_{\scriptscriptstyle F})$		
$T_{\it OFF}$	$\overline{V}_{\scriptscriptstyle IN( ext{min})} {}^-\overline{V}_{\scriptscriptstyle SAT} {}^-\overline{V}_{\scriptscriptstyle OUT}$		
$L_{ ext{ iny (min)}}$	$V_{\scriptscriptstyle IN( ext{min})}$ – $V_{\scriptscriptstyle SAT}$ – $V_{\scriptscriptstyle OUT}$ $\times$ $T_{\scriptscriptstyle ON( ext{max})}$		
	$2 \times I_{\scriptscriptstyle LOAD({ m min})}$		

 $V_{\scriptscriptstyle SAT}$  = Internal switch saturation voltage of the AP1507 = 1.3V

 $V_{\scriptscriptstyle E}$  = Forward voltage drop of output rectifier D1 = 0.5V

**B.** The inductor must be designed so that it does not saturate or significantly saturate at DC current bias of  $I_{PK}$ . ( $I_{PK}$  = Peak inductor or switch current =  $I_{LOAD(\max)} + I_{LOAD(\min)}$ )



#### 3.0.4 Output Capacitor Selection

**A.** The Output Capacitor is required to filter the output and provide regulator loop stability. When selecting an Output Capacitor, the important capacitor parameters are; the 100kHz Equivalent Series Resistance (ESR), the RMS ripples current rating, voltage rating, and capacitance value. For the output capacitor, the ESR value is the most important parameter. The ESR can be calculated from the following formula:

$$ESR = \left(\frac{V_{RIPPLE}}{2 \times I_{LOAD(min)}}\right) -----(3)$$

An aluminum electrolytic capacitor's ESR value is related to the capacitance and its voltage rating. In most cases, higher voltage electrolytic capacitors have lower ESR values. Most of the time, capacitors with much higher voltage ratings may be needed to provide the low ESR values required for low output ripple voltage. If the selected capacitor's ESR is extremely low, it results in an oscillation at the output. It is recommended to replace this low ESR capacitor by using two general standard capacitors in parallel.

**B.** The capacitor's voltage rating should be at least 1.5 times greater than the output voltage, and often much higher voltage ratings are needed to satisfy the low ESR requirements for low output ripple voltage.

#### 3.0.5 Compensation Capacitor Selection

For output voltages greater than approximately 10V, an additional capacitor C1 is required. The compensation capacitor C1 provides additional stability for high output voltages, low input-output voltages, and/or very low ESR output capacitors.

### 3.0.6 Output Rectifier Selection

- **A.** The output rectifier D1 current rating must be greater than the peak switch current I<sub>PK</sub>. The reverse voltage rating of the output rectifier D1 should be at least 1.25 times the maximum input voltage.
- **B.** The output rectifier D1 must be fast (short reverse recovery time) and must be located close to the AP1507 using short leads and short printed circuit traces. Because of their fast switching speed and low forward voltage drop, Schottky Diodes provide the best performance and efficiency, and should be the first choice, especially in low output voltage applications.

#### 3.0.7 Input Capacitor Selection

**A.** The RMS current rating of the input capacitor can be calculated from the following formula table. The capacitor manufacturer's datasheet must be checked to assure that this current rating is not exceeded.

Calculation	Step-down (buck) regulator		
δ	$T_{\rm on}/(T_{\rm on}+T_{\rm off})$		
$I_{PK}$	$I_{\scriptscriptstyle LOAD({ m max})}$ + $I_{\scriptscriptstyle LOAD({ m min})}$		
$I_{m}$	$I_{\scriptscriptstyle LOAD({ m max})} - I_{\scriptscriptstyle LOAD({ m min})}$		
$\Delta I_L$	$2 \times I_{\scriptscriptstyle LOAD({ m min})}$		
I <sub>IN(rms)</sub>	$\sqrt{\delta \times \left[ \left( \boldsymbol{I}_{PK} \times \boldsymbol{I}_{m} \right) + \frac{1}{3} \left( \Delta \boldsymbol{I}_{L} \right)^{2} \right]}$		

**B.** This capacitor should be located close to the IC using short leads and the voltage rating should be approximately 1.5 times the maximum input voltage.

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## 4.0 Design Example

## 4.0.1 Summary of Target Specifications

Input Power	$V_{IN(\max)}$ = +12V; $V_{IN(\min)}$ = +12V
Regulated Output Power	$V_{\scriptscriptstyle OUT}$ = +5V; $I_{\scriptscriptstyle LOAD({ m max})}$ = 3A; $I_{\scriptscriptstyle LOAD({ m min})}$ = 0.3A
Output Ripple Voltage	$V_{\scriptscriptstyle \it RIPPLE}$ $\leq$ 50 mV peak-to-peak
Output Voltage Load Regulation	1% (1/2 full load to full load)
Efficiency	75% minimum at full load.
Switching Frequency	F = 150KHz ± 15 %

## 4.0.2 Calculating and Components Selection

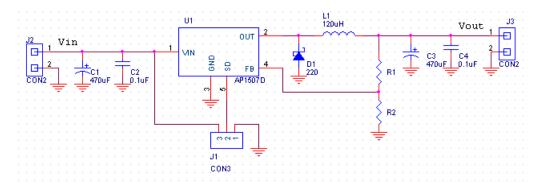
Calculation Formula	Select Condition	Component spec.	
$V_{out} = V_{ref} x ((R1/R2) + 1)$	240Ω≤R2≤1.5KΩ	R1 = 3KΩ; R2 = 1KΩ	
	<b>*</b>		
$L_{\text{(min)}} \ge \frac{[V_{IN\text{(min)}} - V_{SAT} - V_{OUT}] \times T_{ON\text{(max)}}}{2 \times I_{IOAD\text{(min)}}}$	$L_{ ext{(min)}} \ge 44 \text{UH}$		
$L_{\text{(min)}} = 2 \times I_{LOAD(\text{min})}$	$I_{rms} \ge I_{PK} = 1.8A$		
$I_{PK} = I_{LOAD(max)} + I_{LOAD(min)}$			
(V)	ESR≤125mΩ	Select C4 from "LUXON"	
$ESR = \left(\frac{\boldsymbol{V}_{RIPPLE}}{2 \times \boldsymbol{I}_{LOAD(\min)}}\right)$	$V_{\scriptscriptstyle WVDC} \ge 7.5 \text{V}$	220UF/25V*1pcs LY series , or	
$(2 \times I_{LOAD(min)})$	• WVDC	470UF/25V*1pcs LZ series, or 470UF/25V*2pcs SM series	
$V_{WVDC} \ge 1.5 \times V_{OUT}$		47 001 720 V 2p03 OW 301103	
$V_{RRM} \ge 1.25 \times V_{IN(max)}$	$V_{\scriptscriptstyle \it RRM}$ $\geq$ 15V	Select D1: 20V/2A	
$I_{PK} = I_{LOAD(max)} + I_{LOAD(min)}$	$I_{PK} = 1.8A$		
$\begin{bmatrix} c & (c & c & c) & 1 & (c & c & c) \end{bmatrix}$	$I_{ripple} \geq I_{IN(rms)}$ = 1A	Select C2 from "LUXON"	
$I_{IN(rms)} = \sqrt{\delta \times \left  \left( I_{PK} \times I_{m} \right) + \frac{1}{3} \left( \Delta I_{L} \right)^{2} \right }$	11.	470UF/25V*1pcs LY series.  If the +12V power source has a	
V C	$V_{WVDC} \ge 18V$	large output capacitor enough to	
$V_{WVDC} \ge 1.5 \times V_{IN(max)}$	V WVDC = 100	supply this current $m{I}_{\mathit{IN(rms)}}$ , the	
		designer can select another one.	
		470UF/25V*1pcs SM series	



## 4.0.3 Parts List (Board of Materials)

Item	Part Number	MFG/Dist.	Description	Value	Quantity
C1			Aluminum Electrolytic 470uF, 25V		0
C2			Ceramic Capacitor	0.1uF, 25V	1
C3			Aluminum Electrolytic	470uF, 16V	1
C4			Ceramic Capacitor	0.1uF, 25V	1
D1	220		Schottky Diode	20V, 2A	1
J1			Jumper	Pitch = 2.54mm, 3pin	1
J2,J3			Terminal Block	Pitch = 5.08mm, 2pin	2
L1	CSS136S-121M		Inductor	120 UH, 1.8A	1
U1	AP1507D	Anachip	PWM Buck Converter 150kHz, 3A		1
R1	Std		Film Chip Resistor 0Ω		1
R2	Std		Film Chip Resistor OPEN		0

### 4.0.4 Demo Board Schematic



## 4.0.5 Demo Board Efficiency at Vin 12V

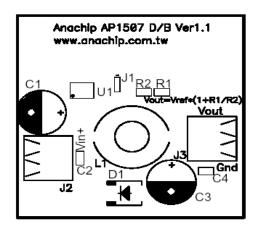
Load	V <sub>out</sub> = 3.3V	V <sub>out</sub> = 5V
0.5A	77.2%	81.6%
1A	80%	83.9%
1.5A	78.6%	83.4%
3A	78.2%	82.2%



## 4.0.6 Typical PC Board Layout

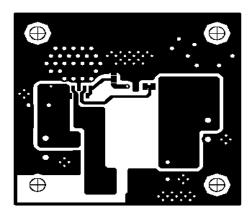


## (1). Component Placement Guide

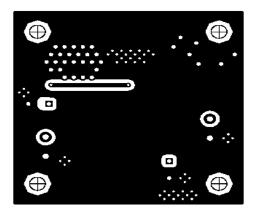




## (2). Component Side PC Board Layout



## (3). Solder Side PC Board Layout







## 4.0.7 Heatsink Layout Guide Line

The heatsink is dependent on the maximum power dissipation and maximum ambient temperature of the application.

### For example

### 12V to 5V/2A

Layout	Top Copper Area (mm*mm)	Bottom Copper Area (mm*mm)	Through Hole	IC Body Temperature	Gnd Pin Temperature
1	49*8	0	0	57	86
2	49*15	49*15	1mm*20	53	63

### 12V to 3.3V/2A

Layout	Top Copper Area (mm*mm)	Bottom Copper Area (mm*mm)	Through Hole	IC Body Temperature	Gnd Pin Temperature
1	49*8	0	0	53	70
2	49*15	49*15	1mm*20	44	57